# Dual General Purpose Transistor

The MBT3906DW1T1 device is a spin-off of our popular SOT-23/SOT-323 three-leaded device. It is designed for general purpose amplifier applications and is housed in the SOT-363 six-leaded surface mount package. By putting two discrete devices in one package, this device is ideal for low-power surface mount applications where board space is at a premium.

## Features

- h<sub>FE</sub>, 100-300
- Low  $V_{CE(sat)}$ ,  $\leq 0.4 \text{ V}$
- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- Available in 8 mm, 7-inch/3,000 Unit Tape and Reel
- Pb-Free Package is Available

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector - Emitter Voltage	V <sub>CEO</sub>	-40	Vdc
Collector - Base Voltage	V <sub>CBO</sub>	-40	Vdc
Emitter – Base Voltage	V <sub>EBO</sub>	-5.0	Vdc
Collector Current – Continuous	Ι <sub>C</sub>	-200	mAdc
Electrostatic Discharge	ESD	HBM Clas MM Clas	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

### THERMAL CHARACTERISTICS

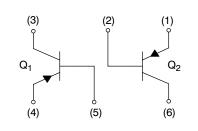
Characteristic	Symbol	Max	Unit
Total Package Dissipation (Note 1) $T_A = 25^{\circ}C$	P <sub>D</sub>	150	mW
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	833	°C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to +150	°C

1. Device mounted on FR4 glass epoxy printed circuit board using the minimum recommended footprint.



## **ON Semiconductor®**

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SOT-363/SC-88 CASE 419B STYLE 1

### MARKING DIAGRAM



A2 = Device Code M = Date Code = Pb-Free Package

(Note: Microdot may be in either location)

## **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MBT3906DW1T1	SOT-363	3000 Units/Reel
MBT3906DW1T1G	SOT-363 (Pb-Free)	3000 Units/Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector - Emitter Breakdown Voltage (Note 2)	V <sub>(BR)CEO</sub>	-40	-	Vdc
Collector - Base Breakdown Voltage	V <sub>(BR)CBO</sub>	-40	-	Vdc
Emitter – Base Breakdown Voltage	V <sub>(BR)EBO</sub>	-5.0	-	Vdc
Base Cutoff Current	I <sub>BL</sub>	-	-50	nAdc
Collector Cutoff Current	I <sub>CEX</sub>	-	-50	nAdc

## **ON CHARACTERISTICS** (Note 2)

$\label{eq:constraint} \begin{array}{ c c c c } DC \ Current \ Gain \\ (I_C = -0.1 \ mAdc, \ V_{CE} = -1.0 \ Vdc) \\ (I_C = -1.0 \ mAdc, \ V_{CE} = -1.0 \ Vdc) \\ (I_C = -10 \ mAdc, \ V_{CE} = -1.0 \ Vdc) \\ (I_C = -50 \ mAdc, \ V_{CE} = -1.0 \ Vdc) \\ (I_C = -100 \ mAdc, \ V_{CE} = -1.0 \ Vdc) \end{array}$	h <sub>FE</sub>	60 80 100 60 30	- - 300 -	-
Collector – Emitter Saturation Voltage ( $I_C = -10 \text{ mAdc}, I_B = -1.0 \text{ mAdc}$ ) ( $I_C = -50 \text{ mAdc}, I_B = -5.0 \text{ mAdc}$ )	V <sub>CE(sat)</sub>	-	-0.25 -0.4	Vdc
Base – Emitter Saturation Voltage $(I_C = -10 \text{ mAdc}, I_B = -1.0 \text{ mAdc})$ $(I_C = -50 \text{ mAdc}, I_B = -5.0 \text{ mAdc})$	V <sub>BE(sat)</sub>	-0.65 -	-0.85 -0.95	Vdc

#### SMALL-SIGNAL CHARACTERISTICS

Current – Gain – Bandwidth Product	f <sub>T</sub>	250	-	MHz
Output Capacitance	C <sub>obo</sub>	-	4.5	pF
Input Capacitance	C <sub>ibo</sub>	-	10.0	pF

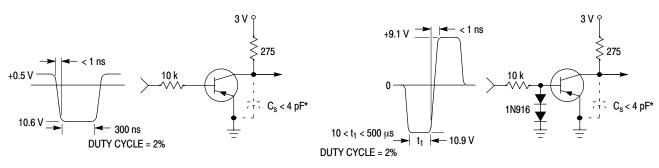
2. Pulse Test: Pulse Width  $\leq$  300  $\mu$ s; Duty Cycle  $\leq$  2.0%.

## **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted) (Continued)

Characteristic	Symbol	Min	Max	Unit	
Input Impedance (V <sub>CE</sub> = -10 Vdc, I <sub>C</sub> = -1.0 mAdc, f = 1.0 kHz)	h <sub>ie</sub>	2.0	12	kΩ	
Voltage Feedback Ratio (V <sub>CE</sub> = -10 Vdc, I <sub>C</sub> = -1.0 mAdc, f = 1.0 kHz)	h <sub>re</sub>	0.1	10	X 10 <sup>-4</sup>	
Small – Signal Current Gain (V <sub>CE</sub> = -10 Vdc, I <sub>C</sub> = -1.0 mAdc, f = 1.0 kHz)	h <sub>fe</sub>	100	400	-	
Output Admittance (V <sub>CE</sub> = -10 Vdc, I <sub>C</sub> = -1.0 mAdc, f = 1.0 kHz)	h <sub>oe</sub>	3.0	60	μmhos	
Noise Figure (V <sub>CE</sub> = -5.0 Vdc, I <sub>C</sub> = -100 μAdc, R <sub>S</sub> = 1.0 k Ω, f = 1.0 kHz)	NF	-	4.0	dB	

## SWITCHING CHARACTERISTICS

Delay Time	$(V_{CC} = -3.0 \text{ Vdc}, V_{BE} = 0.5 \text{ Vdc})$	t <sub>d</sub>	-	35	
Rise Time	$(I_{C} = -10 \text{ mAdc}, I_{B1} = -1.0 \text{ mAdc})$	t <sub>r</sub>	-	35	ns
Storage Time	$(V_{CC} = -3.0 \text{ Vdc}, I_C = -10 \text{ mAdc})$	t <sub>s</sub>	-	225	
Fall Time	(I <sub>B1</sub> = I <sub>B2</sub> = -1.0 mAdc)	t <sub>f</sub>	-	75	ns

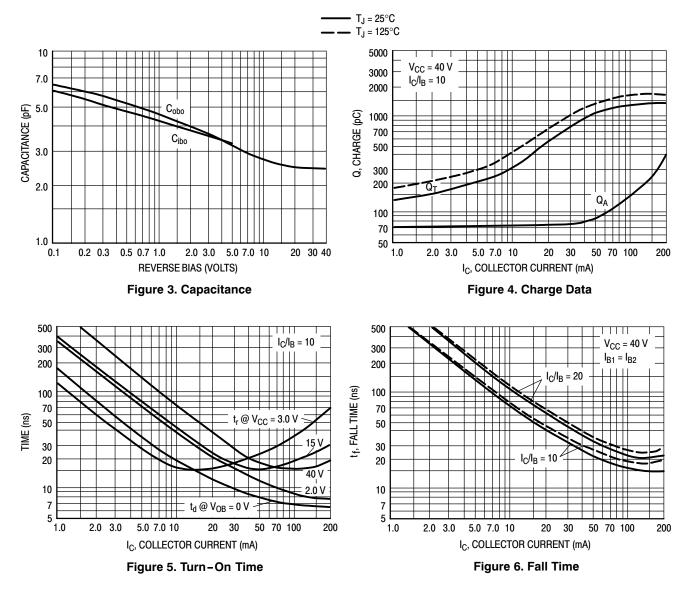


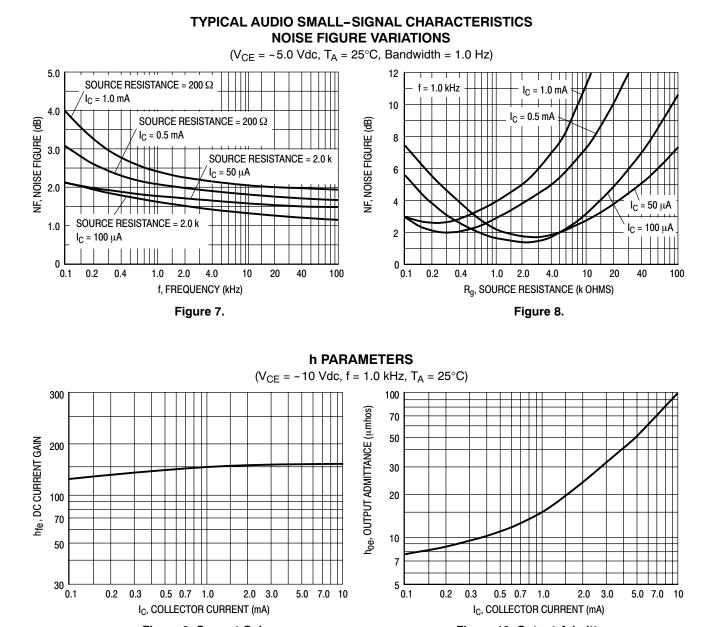
\* Total shunt capacitance of test jig and connectors

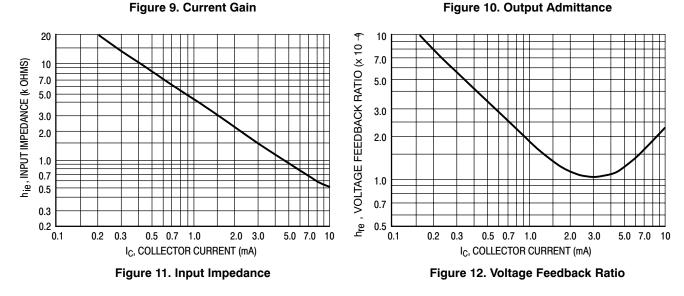
Figure 1. Delay and Rise Time Equivalent Test Circuit

Figure 2. Storage and Fall Time Equivalent Test Circuit

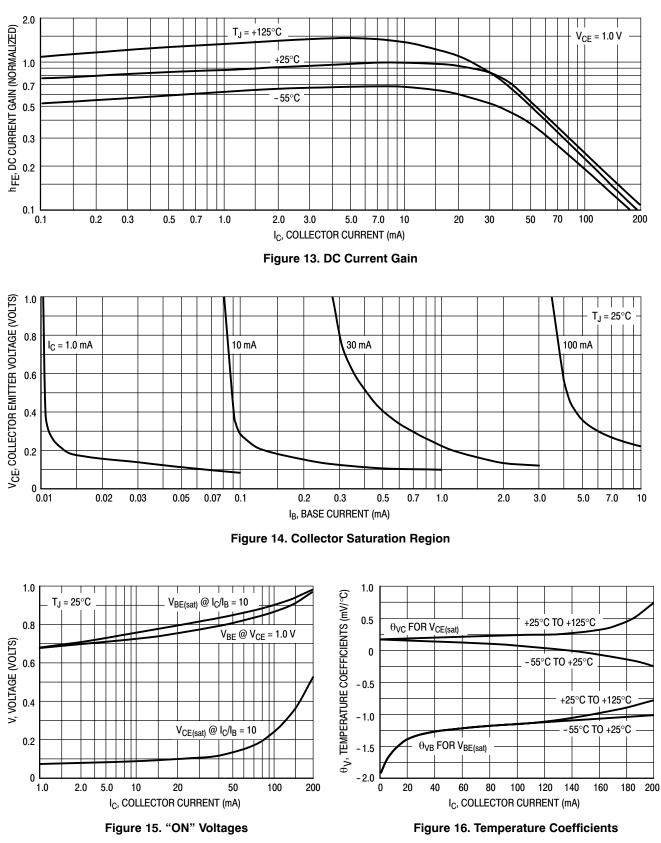
## **TYPICAL TRANSIENT CHARACTERISTICS**





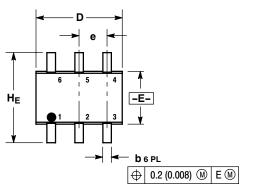


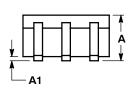
## **TYPICAL STATIC CHARACTERISTICS**

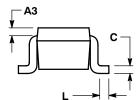


#### PACKAGE DIMENSIONS

SC-88/SC70-6/SOT-363 CASE 419B-02 **ISSUE W** 







NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

2. CONTROLLING DIMENSION: INCH.

3. 419B-01 OBSOLETE, NEW STANDARD 419B-02.

	MIL	LIMETE	RS	INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.80	0.95	1.10	0.031	0.037	0.043	
A1	0.00	0.05	0.10	0.000	0.002	0.004	
A3		0.20 RE	F	(	0.008 RI	EF	
b	0.10	0.21	0.30	0.004	0.008	0.012	
С	0.10	0.14	0.25	0.004	0.005	0.010	
D	1.80	2.00	2.20	0.070	0.078	0.086	
E	1.15	1.25	1.35	0.045	0.049	0.053	
е	0.65 BSC			0.026 BSC			
L	0.10	0.20	0.30	0.004	0.008	0.012	
HE	2.00	2.10	2.20	0.078	0.082	0.086	

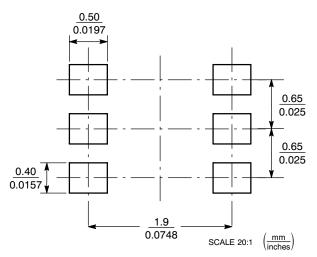
STYLE 1: PIN 1. EMITTER 2

2. BASE 2 3. COLLECTOR 1

4. EMITTER 1 5. BASE 1

6. COLLECTOR 2

**SOLDERING FOOTPRINT\*** 



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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